

# Product Discontinuation Notice for Development Systems Products

XCN21011 (v1.1) July 22, 2021

**Product Discontinuation Notice** 

### **Overview**

The purpose of this notification is to communicate that Xilinx<sup>®</sup> is discontinuing the Kintex<sup>®</sup> UltraScale<sup>™</sup> FPGA KCU1250 Characterization Board, Zynq<sup>®</sup> UltraScale+ RFSoC ZCU216 Production Evaluation Kit, Zynq UltraScale+ RFSoC Gen 3 8T8R Limited Distribution Evaluation Kit, Zynq UltraScale+ RFSoC Gen 3 16T16R Limited Distribution Evaluation Kit, and Vivado<sup>®</sup> Design and System Editions.

# **Description**

As part of Xilinx regular product pruning activities, the following products have been identified for obsolescence. This notice should be used in conjunction with previous discontinuance notices which can be found at Xilinx.com.

## **Products Affected**

- Kintex UltraScale FPGA KCU1250 Characterization Board
- Zyng UltraScale+ RFSoC ZCU216 Production Evaluation Kit
- Zynq UltraScale+ RFSoC Gen 3 8T8R Limited Distribution Evaluation Kit
- Zyng UltraScale+ RFSoC Gen 3 16T16R Limited Distribution Evaluation Kit
- Vivado Design and System Editions

#### Table 1: Kintex UltraScale FPGA KCU1250 Characterization Board

Part Number	Description	Replacement Part
CK-U1-KCU1250-G	Xilinx Kintex UltraScale FPGA KCU1250 Characterization Board	No Replacement
CK-U1-KCU1250-G-J	Xilinx Kintex UltraScale FPGA KCU1250 Characterization Board, Japan Specific	No Replacement

#### Table 2: Zyng UltraScale+ RFSoC ZCU216 Production Evaluation Kit

Part Number	Description	Replacement Part
EK-U1-ZCU216-G	Xilinx Zynq UltraScale+ RFSoC ZCU216 Production Evaluation Kit	EK-U1-ZCU216-V1-G
EK-U1-ZCU216-G-J	Xilinx Zynq UltraScale+ RFSoC ZCU216 Production Evaluation Kit, Japan Specific	EK-U1-ZCU216-V1-G-J

#### Table 3: Zynq UltraScale+ RFSoC Gen 3 8T8R Limited Distribution Evaluation Kit

Part Number	Description	Replacement Part
EK-U1-ZCU208-ES1-G-	Xilinx Zynq UltraScale+ RFSoC Gen 3 8T8R Limited Distribution	EK-U1-ZCU208-V1-G-
LD	Evaluation Kit	LD

#### Table 4: Zynq UltraScale+ RFSoC Gen 3 16T16R Limited Distribution Evaluation Kit

Part Number	Description	Replacement Part
EK-U1-ZCU216-ES1-G- LD	Xilinx Zynq UltraScale+ RFSoC Gen 3 16T16R Limited Distribution Evaluation Kit	EK-U1-ZCU216-V1-G-
LD	Distribution Evaluation (it	LD

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Table 5: Vivado Design and System Editions

Part Number	Description	Replacement Part	Description
EF-VIVADO-DESIGN-NL	Vivado HL Design Edition,	EF-VIVADO-ENTER-NL	Vivado ML Enterprise Edition,
	Node-Locked License		Node-Locked License
EF-VIVADO-DESIGN-FL	Vivado HL Design Edition,	EF-VIVADO-ENTER-FL	Vivado ML Enterprise Edition,
	Floating License		Floating License
EF-VIVADO-SYSTEM-NL	Vivado HL System Edition,	EF-VIVADO-ENTER-NL	Vivado ML Enterprise Edition,
	Node-Locked License	EF-VIVADO-ENTER-INL	Node-Locked License
EF-VIVADO-SYSTEM-FL	Vivado HL System Edition,	EF-VIVADO-ENTER-FL	Vivado ML Enterprise Edition,
	Floating License	EF-VIVADO-ENTER-FL	Floating License

## **Key Dates and Ordering Information**

- Kintex UltraScale FPGA KCU1250 Characterization Board (<u>Table 1</u>)
  Final orders accepted until January 31<sup>st</sup>, 2022 or until inventory is exhausted whichever comes first.
  Final shipments will be until February 28<sup>th</sup>, 2022.
- Zynq UltraScale+ RFSoC ZCU216 Production Evaluation Kit (<u>Table 2</u>)
   Final orders accepted until October 31<sup>st</sup>, 2021 or until inventory is exhausted whichever comes first.
   Final shipments will be until November 30<sup>th</sup>, 2021.
- Zynq UltraScale+ RFSoC Gen 3 8T8R Limited Distribution Evaluation Kit (<u>Table 3</u>)
   Final orders accepted until January 31<sup>st</sup>, 2022 or until inventory is exhausted whichever comes first.
   Final shipments will be until February 28<sup>th</sup>, 2022.
- Zynq UltraScale+ RFSoC Gen 3 16T16R Limited Distribution Evaluation Kit (<u>Table 4</u>)
  Final orders accepted until January 31<sup>st</sup>, 2022 or until inventory is exhausted whichever comes first.
  Final shipments will be until February 28<sup>th</sup>, 2022.
- Vivado Design and System Editions (<u>Table 5</u>)
  Final orders accepted until July 31<sup>st</sup>, 2021. All orders will be deemed Non-Cancellable, Non-Returnable.
  Final shipment will be until August 2<sup>nd</sup>, 2021.

# Response

Customers are requested to place last-time-buy orders in a timely manner prior to the key dates listed above to avoid product availability issues. If you anticipate that your last time buy requirements will exceed the current rate, please provide your Xilinx Sales Representative with a forecast of the requirements. All orders will be supported on a first-come, first-served basis with the non-cancellable and non-returnable (NCNR) condition. For additional information or questions, contact your local Xilinx Sales representative.

Important Notice: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<a href="http://www.xilinx.com/support">http://www.xilinx.com/support</a>). Register today and personalize your "Documentation and Design Advisory Alerts" area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to Xilinx Answer Record 18683



## **Revision History**

The following table shows the revision history for this document.

Date	Version	Revision
07/12/2021	v1.0	Initial release.
07/22/2021	v1.1	Updated Vivado final shipment date.

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